



APP N 10/772,606

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Joseph E. Geusic et al.

Examiner: Julio J Maldonado

Serial No.: 10/772,606

Group Art Unit: 2823

Filed: February 5, 2004

Docket No.: 303.390US4

Title: INTEGRATED CIRCUITS USING OPTICAL FIBER INTERCONNECTS
FORMED THROUGH A SEMICONDUCTOR WAFER

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This paper responds to the Office Action mailed on February 9, 2005. Please amend the above-identified patent application as follows.

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